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### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

# **FW811** — General-Purpose Switching Device Applications

#### **Features**

- · 4V drive.
- · Composite type, facilitating high-density mounting.

#### **Specifications**

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		35	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		8	Α
Drain Current (PW≤10s)	ID	Duty cycle≤1%	9	Α
Drain Current (PW≤10μs)	IDP	Duty cycle≤1%	52	Α
Allowable Power Dissipation	PD	When mounted on ceramic substrate (2000mm²x0.8mm) 1unit, PW≤10s	2.0	W
Total Dissipation	PT	When mounted on ceramic substrate (2000mm²x0.8mm), PW≤10s	2.2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V	35			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =35V, V <sub>GS</sub> =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±16V, V <sub>DS</sub> =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =8A	2.7	4.5		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	I <sub>D</sub> =8A, V <sub>GS</sub> =10V		18	24	mΩ
	R <sub>DS</sub> (on)2	I <sub>D</sub> =4A, V <sub>GS</sub> =4.5V		29	41	mΩ
	RDS(on)3	ID=4A, VGS=4V		39	55	mΩ

Marking: W811 Continued on next page.

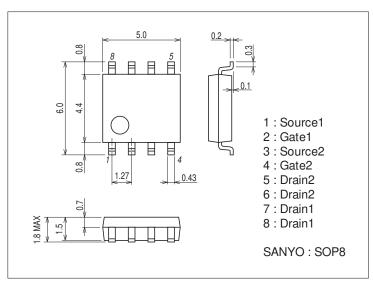
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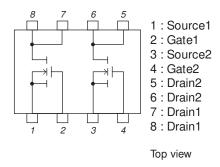
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Input Capacitance	Ciss	V <sub>DS</sub> =20V, f=1MHz		660		pF
Output Capacitance	Coss	V <sub>DS</sub> =20V, f=1MHz		90		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =20V, f=1MHz		60		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		10		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit.		50		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		40		ns
Fall Time	tf	See specified Test Circuit.		40		ns
Total Gate Charge	Qg	V <sub>DS</sub> =20V, V <sub>GS</sub> =10V, I <sub>D</sub> =8A		13.0		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =20V, V <sub>GS</sub> =10V, I <sub>D</sub> =8A		2.4		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =20V, V <sub>GS</sub> =10V, I <sub>D</sub> =8A		3.2		nC
Diode Forward Voltage	V <sub>SD</sub>	IS=8A, VGS=0V		0.81	1.2	V

#### **Package Dimensions**

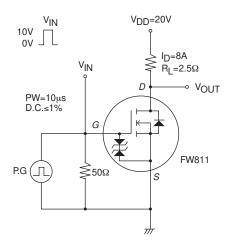
unit : mm (typ) 7005A-003

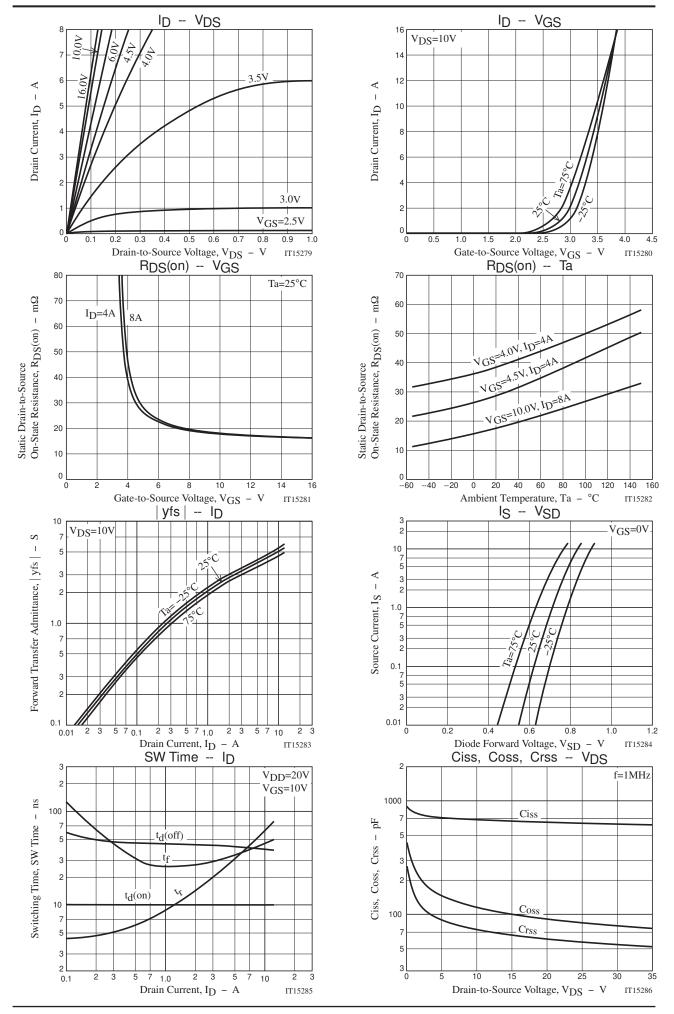


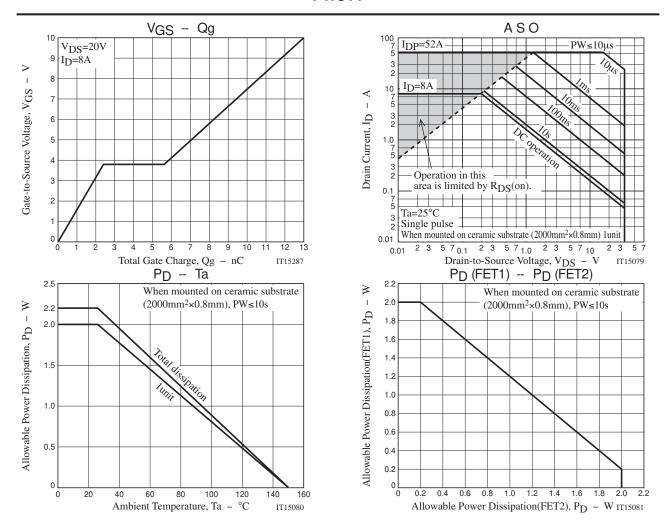
#### **Electrical Connection**



#### **Switching Time Test Circuit**







Note on usage: Since the FW811 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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